

Excellent Integrated System Limited

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SunLED XZMYLA143S

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



Distributor of SunLED: Excellent Integrated System Limited Datasheet of XZMYLA143S - LED 5.6X3MM YLW WATER CLEAR SMD Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Part Number: XZMYLA143S

5.6mm x 3.0mm SURFACE MOUNT LED LAMP

Features

- 5.6mm x 3.0mm x 0.77mm SMD LED
- IR-reflow compatible
- Standard Package: 2,000pcs / Reel
- White SMD package with silicone resin
- MSL (Moisture Sensitivity Level): 2a
- RoHS compliant



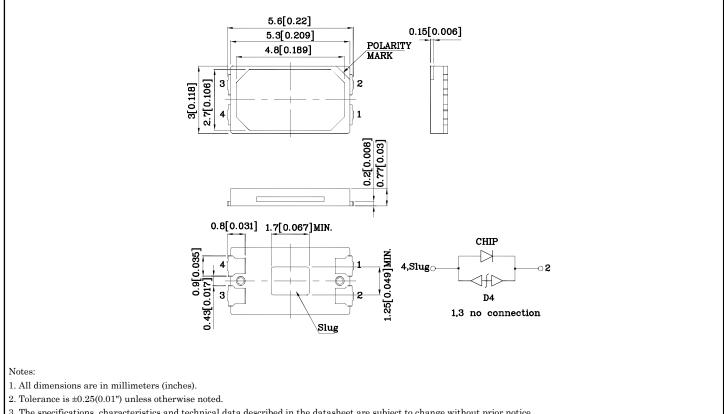


ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Typical Applications

- Entertainment and accent lighting
- Architectural lighting
- Ideal substitute for halogen and florescent lighting
- Automotive interior and exterior lighting
- Specialty lighting (Markers, Beacon, Pathway)

Package Schematics



3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



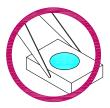
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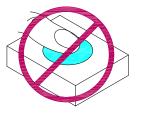
Handling Precautions

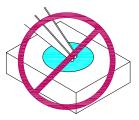
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

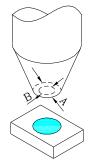




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.

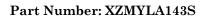


4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.





5.6mm x 3.0mm SURFACE MOUNT LED LAMP

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \mbox{Luminous Intensity} \\ \mbox{CIE127-2007*} \\ \mbox{(I_F=150mA) [2]} \\ \mbox{cd} \end{array}$		Luminous Flux CIE127-2007* (I _F =150mA)[2] lm		Viewing Angle 2 0 1/2 [1]
				Min.	Тур.	Min.	Тур.	
XZMYLA143S	Yellow	AlGaInP	Water Clear	3.6*	4.19*	12*	14.7*	120°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. LEDs are binned according to their luminous flux.

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* Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	PD	495	mW	
Junction Temperature [1]	TJ	110	°C	
Operating Temperature	Тор	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	°C	
DC Forward Current [1]	IF	150	mA	
Reverse Voltage	VR	5	V	
Peak Forward Current [2]	IFM	270	mA	
Thermal Resistance [1] (Junction/ambient)	Rth j-a	150	°C/W	
Thermal Resistance [1] (Junction/solder point)	Rth j-S	70	°C/W	
Electrostatic Discharge Threshold (HBM)	8000	V		

Notes:

1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad)

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

Electrical / Optical Characteristics at TA=25°C

	Symbol		TT •/		
Parameter		Min.	Тур.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF=150mA	λpeak		590*		nm
Dominant Wavelength CIE127-2007* IF=150mA	λdom [1]		590*		nm
Spectral bandwidth at 50% Φ REL MAX IF = 150mA	$ riangle\lambda$		20		nm
Forward Voltage IF=150mA	Vf [2]	2.2	2.7	3.3	V
Allowable Reverse Current	IR			85	mA
Temperature coefficient of λpeak IF=150mA, -10°C≤ T≤100°C	TCλpeak		0.13		nm/°C
Temperature coefficient of λdom IF=150mA, -10°C≤ T≤100°C	TCλdom		0.10		nm/°C
Temperature coefficient of VF IF=150mA, -10°C≤ T≤100°C	TCv		-1.7		mV/°C

Notes:

1. The dominant Wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)

2. Forward Voltage: +/-0.1V.

* Wavelength is in accordance with CIE127-2007 standards. Nov 15,2013

XDSB7607 V1-Z Layout: Maggie L.



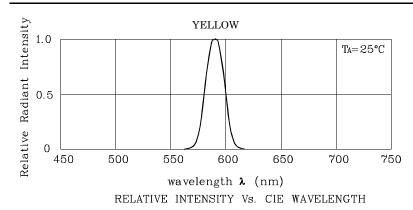
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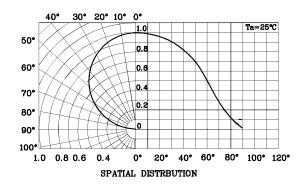
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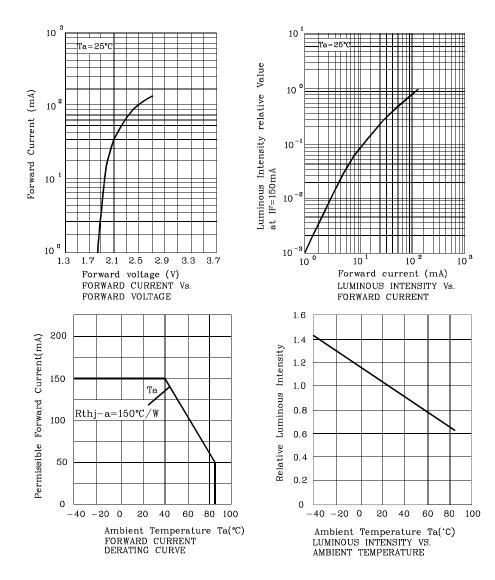
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5.6mm x 3.0mm SURFACE MOUNT LED LAMP





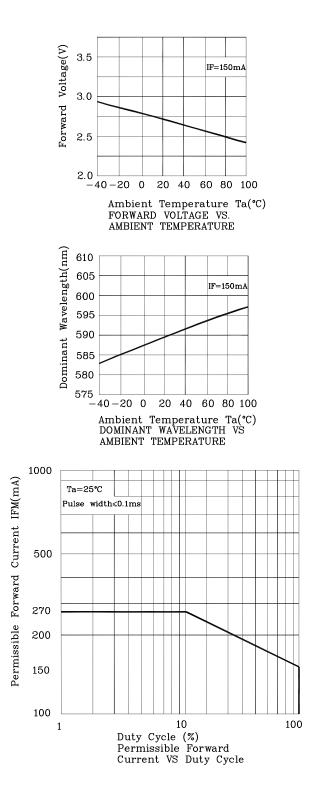


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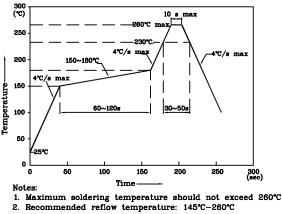
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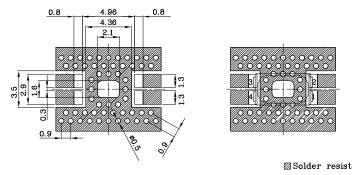
LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



- Do not put stress to the epoxy resin during
- З. high temperatures conditions

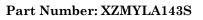
Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)



0.8mm FR4-Based Boards

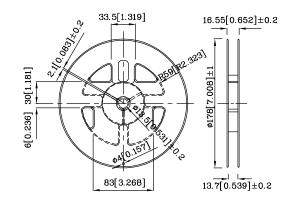
For both the open via PTH and filled and capped via design, the finished hole diameter is 0.5mm. A smaller diameter will lead to an increase of thermal resistance. The recommended distance between two holes is 0.4 mm.This results in a minimal pitch of 0.9mm between the vias

Tape Specification (Units : mm)

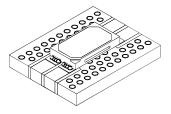


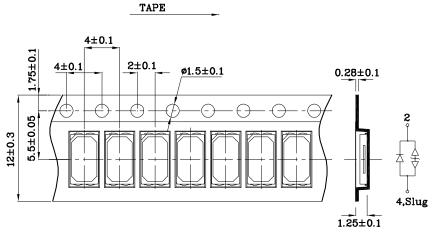
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Reel Dimension



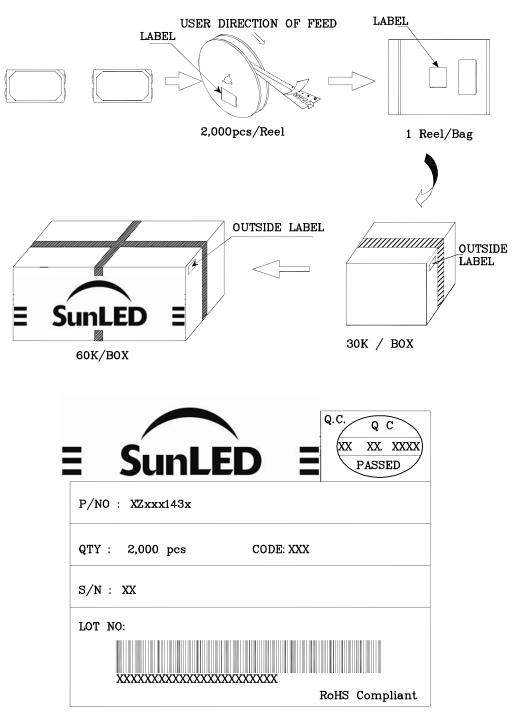
♦ The device has a single mounting surface. The device must be mounted according to the specifications.







PACKING & LABEL SPECIFICATIONS



TERMS OF USE

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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at http://www.SunLEDusa.com/TechnicalNotes.asp

Nov 15,2013

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